WHAT IS CLAIMED IS:

1. An electronic device ~~(500)~~ comprising:

a dielectric substrate ~~(502)~~ having a first surface ~~(504)~~;

a conductive circuit ~~(520)~~ deposited on the first surface, the conductive circuit comprising a printed conductive ink trace ~~(520)~~ on the first surface; and

a conductive interposer ~~(530)~~ mechanically coupled to the substrate, the conductive interposer being electrically coupled to the conductive circuit, the conductive interposer having a separable contact interface ~~(532)~~ configured to be mechanically and electrically connected to a removable contact ~~(552)~~.

2. The electronic device ~~(500)~~ of claim 1, wherein the conductive interposer ~~(530)~~ comprises a post ~~(538)~~ extending through the conductive circuit into the substrate ~~(502)~~, the post fixing the relative position between the conductive interposer and the substrate.

3. The electronic device ~~(500)~~ of claim 2, wherein the conductive interposer comprises an arm ~~(536)~~ extending from the post ~~(538)~~ along the first surface ~~(504)~~, the conductive circuit ~~(520)~~ being positioned between the arm and the first surface, the arm defining the separable contact interface ~~(532)~~.

4. The electronic device ~~(500)~~ of claim 1, wherein the conductive interposer ~~(530)~~ comprises a main body ~~(534)~~ and a flexible element ~~(540)~~ extending between the main body and the conductive circuit ~~(520)~~, the flexible element electrically connecting the conductive circuit with the main body, the main body defining the separable contact interface ~~(532)~~ with the removable contact.

5. The electronic device ~~(500)~~ of claim 1, wherein the conductive interposer ~~(530)~~ comprises a flexible, conductive gasket ~~(540)~~ directly engaging and being electrically connected to the conductive circuit ~~(520)~~.

6. The electronic device ~~(600)~~ of claim 1, wherein the conductive interposer ~~(630)~~ comprises a flexible spring beam ~~(640)~~ directly engaging and being electrically connected to the conductive circuit ~~(620)~~.

7. The electronic device ~~(500)~~ of claim 1, wherein the conductive interposer ~~(530)~~ is connected to the conductive circuit ~~(520)~~ along a wiping contact surface, the conductive interposer allowing non-damaging wiping to occur between the conductive interposer and the conductive circuit.

8. The electronic device ~~(100)~~ of claim 1, wherein the printed conductive ink trace ~~(120)~~ is applied to the first surface ~~(104)~~ and to the conductive interposer ~~(130)~~.

9. The electronic device ~~(100)~~ of claim 1, wherein the conductive circuit ~~(120)~~ comprises an antenna, the contact comprises ~~(152)~~ a feed line attached to the antenna by the conductive interposer.

10. The electronic device ~~(100)~~ of claim 1, wherein the substrate ~~(102)~~ comprises a case of the electronic device, the conductive circuit ~~(120)~~ being applied directly to the case, the case being configured to hold electronic components ~~(150)~~ therein.